Overview

Fidelica develops and markets leading edge micro-pressure sensor technology. The first commercial application is designed to support fingerprint image capturing and comparison applications. The Fidelica Model FIS– 3001 (Fidelica Image Sensor model 3001) is designed to be embedded into microprocessor based devices. When integrated with applicable host components, this sensor enables users to perform a variety of local, remote, mobile and online electronic authentication security functions.

*Schematic of a typical fingerprint recognition system*
Specifications

Mechanical

Size overall
• 16.2mm W x 18.2mm L x 1.0mm H (.63 in. x .71 in. x .039 in.)

Sensor/image size
• 12.8mm x 12.8mm (0.5 in. x 0.5 in.) imaging area

Weight
• 2g

Sensor image resolution
• 508 dpi
Specifications

Reliability

Temperature
- Operating
  Minimum: 0°C (32°F)
  Maximum: 60°C (140°F)
- Storage and shipping temperature
  Minimum: -40°C (-40°F)
  Maximum: 65°C (149°F)

Humidity
- 5% to 95% non-condensing

Altitude
- Operating: 10,000 ft.

Shock
- Operating: 10g, 6ms, half sine wave
- Non-operating: 10g, 6ms, half sine wave

Vibration
- Operating: 11.69g (50-2000 Hz)
- Non-operating: 11.69g (50-2000 Hz)

Lifetime MTTF
- Touch surface life: 1,000,000+ touches (estimated life in excess of 5yrs)

Performance¹
- Scan time <1 second
- False Accept Rate (FAR) <.001%
- False Reject Rate (FRR) <.1%
- Bad cells in array <2%
- Bad rows and columns in array <2%, non adjacent

Interface
- Serial data output/USB compatible

Notes:

1. FAR and FRR performance for this sensor release is <2% FRR at .001% FAR. Results were obtained from a randomly acquired image without considering angular position of the finger and the population (background, gender, occupation or age).
Applications

- Wireless
- Personal Computing
- Workstations
- PDA
- Game Consoles
- Physical Access
- Law Enforcement

Features
- Lowest power consumption in the industry
- Smaller than a postage stamp
- Pure binary image output
- Sensor array is not based on CMOS
- No image calibration necessary
- 508 dpi resolution
- Passive pressure sensing array

Benefits
- Ideal for wireless applications
- Embeds into any mobile device
- Low software overhead
- ESD resistant
- Faster image acquisition time
- Conforms to FBI standard
- Durable user interface
Contact

Fidelica Microsystems, Inc.

Corporate Headquarters
423 Dixon Landing Road
Milpitas, CA 95035

Operations
75 Robin Hill Road
Santa Barbara, CA 93117

Main:
(408) 941-7900

Fax:
(408) 941-8149

Email:
marketing@fidelica.com
sales@fidelica.com
info@fidelica.com

Web:
www.fidelica.com